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STW70N65M2

N-channel 650 V, 0.039 Ω typ., 63 A MDmesh[™] M2 Power MOSFET in a TO-247 package

Datasheet - production data



Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	ID
STW70N65M2	650 V	0.046 Ω	63 A

- Extremely low gate charge
- Excellent output capacitance (C_{OSS}) profile
- 100% avalanche tested
- Zener-protected

Applications

• Switching applications

Description

This device is an N-channel Power MOSFET developed using MDmesh[™] M2 technology. Thanks to its strip layout and an improved vertical structure, the device exhibits low on-resistance and optimized switching characteristics, rendering it suitable for the most demanding high efficiency converters.

Table 1: Device summary

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Order code	Marking	Package	Packaging		
STW70N65M2	70N65M2	TO-247	Tube		

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This is information on a product in full production.

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{GS}	Gate-source voltage	± 25	V
I _D	Drain current (continuous) at $T_c = 25 \text{ °C}$	63	А
ID	Drain current (continuous) at T _C = 100 °C	40	А
I _{DM} ⁽¹⁾	Drain current (pulsed)	252	А
Ρτοτ	Total dissipation at $T_C = 25 \text{ °C}$	446	W
dv/dt ⁽²⁾	Peak diode recovery voltage slope	15	V/ns
dv/dt ⁽³⁾	MOSFET dv/dt ruggedness	50	V/ns
T _{stg}	Storage temperature range	55 to 150	÷C
Tj	Operating junction temperature range	- 55 10 150	0

Notes:

 $^{(1)}\mbox{Pulse}$ width limited by safe operating area.

 $^{(2)}$ I_{SD} ≤ 63 A, di/dt ≤ 400 A/µs; V_{DS peak} < V(BR)DSS, V_{DD} = 400 V

⁽³⁾ $V_{DS} \le 520 \text{ V}$

Table 3: Thermal data

Symbol	Parameter	Value	Unit
$R_{thj-case}$	Thermal resistance junction-case max	0.28	°C/W
R _{thj-amb}	Thermal resistance junction-ambient max	50	°C/W

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetetive or not repetetive (pulse width limited by $T_{jmax})$	4	А
E _{AS}	Single pulse avalanche energy (starting T_j = 25 °C, I_D = $I_{AR},$ V_{DD} = 50 V)	3500	mJ



2 Electrical characteristics

(T_C= 25 °C unless otherwise specified)

Table 5: On/off states							
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0 V, I_D = 1 mA$	650			V	
	Zava sata valta na duain	$V_{GS} = 0 V, V_{DS} = 650 V$			1	μA	
I _{DSS}	current	$V_{GS} = 0 V, V_{DS} = 650 V,$ $T_{C} = 125 \circ C^{(1)}$			100	μA	
I _{GSS}	Gate-body leakage current	V_{DS} = 0 V, V_{GS} = ± 25 V			±5	μA	
$V_{GS(th)}$	Gate threshold voltage	V_{DS} = V_{GS} , I_D = 250 μ A	2	3	4	V	
$R_{\text{DS(on)}}$	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 31.5 \text{ A}$		0.039	0.046	Ω	

Notes:

⁽¹⁾Defined by design, not subject to production test.

Symbol	Paramotor		Min	Typ	Mox	Unit
Symbol	Falailletei	Test conditions		тур.	IVIAA.	Unit
Ciss	Input capacitance		-	5140	-	pF
Coss	Output capacitance	V_{DS} = 100 V, f = 1 MHz,	-	208	-	pF
C _{rss}	Reverse transfer capacitance	$V_{GS} = 0 V$	-	2.9	-	pF
Coss eq. ⁽¹⁾	Equivalent output capacitance	V_{DS} = 0 V to 520 V, V_{GS} = 0 V	-	520	-	pF
R _G	Intrinsic gate resistance	$f = 1 \text{ MHz}, I_D=0 \text{ A}$	-	3	-	Ω
Qg	Total gate charge	$V_{DD} = 520 \text{ V}, I_D = 63 \text{ A},$	-	117	-	nC
Q _{gs}	Gate-source charge	V _{GS} = 10 V (see Figure 15: "Test circuit for gate charge	-	21.5	-	nC
Q _{gd}	Gate-drain charge	behavior")	-	51	-	nC

Table 6: Dynamic

Notes:

 $^{(1)}C_{oss~eq.}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
t _{d(on)}	Turn-on delay time	$V_{DD} = 325 \text{ V}, \text{ I}_{D} = 31.5 \text{ A}$	-	24	-	ns	
tr	Rise time	$R_G = 4.7 \Omega, V_{GS} = 10 V$ (see <i>Figure 14: "Test circuit for</i>		22	-	ns	
t _{d(off)}	Turn-off-delay time	resistive load switching times" and	-	134	-	ns	
t _f	Fall time	Figure 19: "Switching time waveform")		11	-	ns	

Table 1. Switching lines	Table	7: Sv	vitching	times
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Electrical characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		63	А
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		252	A
V _{SD} ⁽²⁾	Forward on voltage	V_{GS} = 0 V, I_{SD} = 63 A	-		1.6	V
t _{rr}	Reverse recovery time	I_{SD} = 63 A, di/dt = 100 A/µs,	-	584		ns
Q _{rr}	Reverse recovery charge	V _{DD} = 60 V (see Figure 16: "Test circuit for	-	14.5		μC
I _{RRM}	Reverse recovery current	inductive load switching and diode recovery times")	-	50.5		А
t _{rr}	Reverse recovery time	$I_{SD} = 63 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	725		ns
Q _{rr}	Reverse recovery charge	$V_{DD} = 60 \text{ V}, \text{ T}_{j} = 150 \text{ °C}$ (see <i>Figure 16: "Test circuit for</i>	-	20		μC
I _{RRM}	Reverse recovery current	inductive load switching and diode recovery times")	-	55.5		A

Notes:

 ${}^{(1)}\mbox{Pulse}$ width is limited by safe operating area

 $^{(2)}\text{Pulse test: pulse duration}$ = 300 $\mu\text{s},$ duty cycle 1.5%







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Electrical characteristics









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3 Test circuits









4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

4.1 TO-247 package information





Package mechanical data

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Table 9: TO-247 package mechanical data						
Dim		mm.				
Dim.	Min.	Тур.	Max.			
А	4.85		5.15			
A1	2.20		2.60			
b	1.0		1.40			
b1	2.0		2.40			
b2	3.0		3.40			
С	0.40		0.80			
D	19.85		20.15			
E	15.45		15.75			
е	5.30	5.45	5.60			
L	14.20		14.80			
L1	3.70		4.30			
L2		18.50				
ØP	3.55		3.65			
ØR	4.50		5.50			
S	5.30	5.50	5.70			

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5 Revision history

Table 10: Document revision history

Date	Revision	Changes
04-Feb-2016	1	First release.



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